

LM431 Adjustable Precision Zener Shunt Regulator

 Check for Samples: [LM431](#)

FEATURES

- Average Temperature Coefficient 50 ppm/°C
- Temperature Compensated for Operation Over the Full Temperature Range
- Programmable Output Voltage
- Fast Turn-On Response
- Low Output Noise

DESCRIPTION

The LM431 is a 3-terminal adjustable shunt regulator with ensured temperature stability over the entire temperature range of operation. The output voltage may be set at any level greater than 2.5V (V_{REF}) up to 36V merely by selecting two external resistors that act as a voltage divided network. Due to the sharp turn-on characteristics this device is an excellent replacement for many zener diode applications.

Connection Diagram

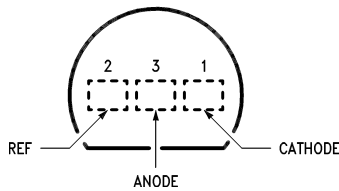


Figure 1. TO-92: Plastic Package Top View

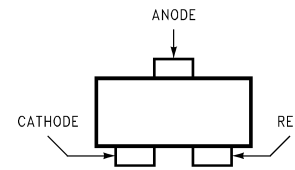


Figure 2. SOT-23: 3-Lead Small Outline Top View

A. Note: NC = Not internally connected.

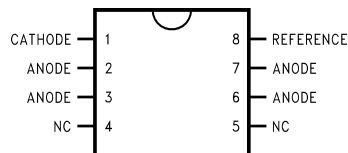
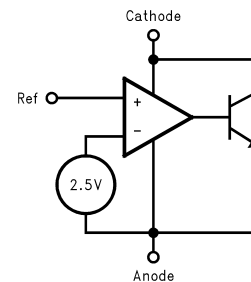
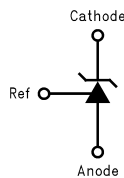


Figure 3. SOIC: 8-Pin Surface Mount Top view

Symbol and Functional Diagrams



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DC Test Circuits

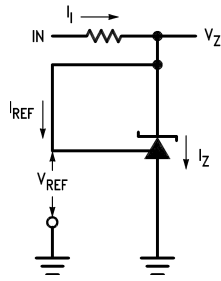


Figure 4. Test Circuit for $V_Z = V_{REF}$

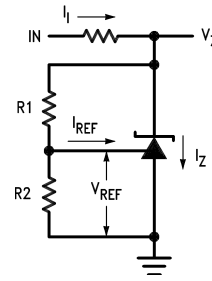


Figure 5. Test Circuit for $V_Z > V_{REF}$

Note: $V_Z = V_{REF} (1 + R1/R2) + I_{REF} \cdot R1$

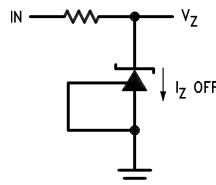


Figure 6. Test Circuit for Off-State Current



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾⁽²⁾

Storage Temperature Range		-65°C to +150°C
Operating Temperature Range	Industrial (LM431xI)	-40°C to +85°C
	Commercial (LM431xC)	0°C to +70°C
Soldering Information	Infrared or Convection (20 sec.)	235°C
	Wave Soldering (10 sec.)	260°C (lead temp.)
Cathode Voltage		37V
Continuous Cathode Current		-10 mA to +150 mA
Reference Voltage		-0.5V
Reference Input Current		10 mA
Internal Power Dissipation ⁽³⁾⁽⁴⁾	TO-92 Package	0.78W
	SOIC Package	0.81W
	SOT-23 Package	0.28W

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its rated operating conditions.
- (2) If Military/Aerospace specified devices are required, please contact the TI Sales Office/ Distributors for availability and specifications.
- (3) $T_{J \text{ Max}} = 150^\circ\text{C}$.
- (4) Ratings apply to ambient temperature at 25°C. Above this temperature, derate the TO-92 at 6.2 mW/°C, the SOIC at 6.5 mW/°C, the SOT-23 at 2.2 mW/°C.

Operating Conditions

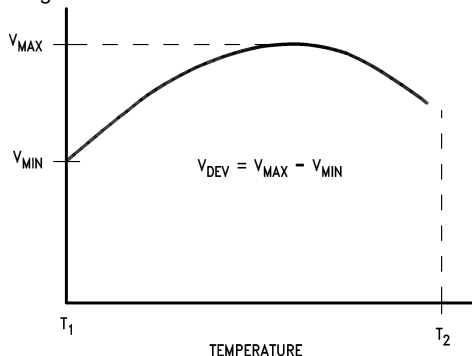
	Min	Max
Cathode Voltage	V_{REF}	37V
Cathode Current	1.0 mA	100 mA

LM431 Electrical Characteristics

T_A = 25°C unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V _{REF}	Reference Voltage	V _Z = V _{REF} , I _I = 10 mA LM431A (Figure 4)	2.440	2.495	2.550	V
		V _Z = V _{REF} , I _I = 10 mA LM431B (Figure 4)	2.470	2.495	2.520	V
		V _Z = V _{REF} , I _I = 10 mA LM431C (Figure 4)	2.485	2.500	2.510	V
V _{DEV}	Deviation of Reference Input Voltage Over Temperature ⁽¹⁾	V _Z = V _{REF} , I _I = 10 mA, T _A = Full Range (Figure 4)		8.0	17	mV
ΔV _{REF} /ΔV _Z	Ratio of the Change in Reference Voltage to the Change in Cathode Voltage	I _Z = 10 mA (Figure 5)	V _Z from V _{REF} to 10V	-1.4	-2.7	mV/V
			V _Z from 10V to 36V	-1.0	-2.0	
I _{REF}	Reference Input Current	R ₁ = 10 kΩ, R ₂ = ∞, I _I = 10 mA (Figure 5)		2.0	4.0	μA
αI _{REF}	Deviation of Reference Input Current over Temperature	R ₁ = 10 kΩ, R ₂ = ∞, I _I = 10 mA, T _A = Full Range (Figure 5)		0.4	1.2	μA
I _{Z(MIN)}	Minimum Cathode Current for Regulation	V _Z = V _{REF} (Figure 4)		0.4	1.0	mA
I _{Z(OFF)}	Off-State Current	V _Z = 36V, V _{REF} = 0V (Figure 6)		0.3	1.0	μA
r _Z	Dynamic Output Impedance ⁽²⁾	V _Z = V _{REF} , LM431A, Frequency = 0 Hz (Figure 4)			0.75	Ω
		V _Z = V _{REF} , LM431B, LM431C Frequency = 0 Hz (Figure 4)			0.50	Ω

- (1) Deviation of reference input voltage, V_{DEV}, is defined as the maximum variation of the reference input voltage over the full temperature range.



The average temperature coefficient of the reference input voltage, αV_{REF}, is defined as:

$$\alpha V_{REF} \frac{\text{ppm}}{^{\circ}\text{C}} = \frac{\pm \left[\frac{V_{\text{Max}} - V_{\text{Min}}}{V_{REF}(\text{at } 25^{\circ}\text{C})} \right] 10^6}{T_2 - T_1} = \frac{\pm \left[\frac{V_{DEV}}{V_{REF}(\text{at } 25^{\circ}\text{C})} \right] 10^6}{T_2 - T_1}$$

Where:

T₂ - T₁ = full temperature change (0-70°C).

V_{REF} can be positive or negative depending on whether the slope is positive or negative.

Example: V_{DEV} = 8.0 mV, V_{REF} = 2495 mV, T₂ - T₁ = 70°C, slope is positive.

$$\alpha V_{REF} = \frac{\left[\frac{8.0 \text{ mV}}{2495 \text{ mV}} \right] 10^6}{70^{\circ}\text{C}} = +46 \text{ ppm}/^{\circ}\text{C}$$

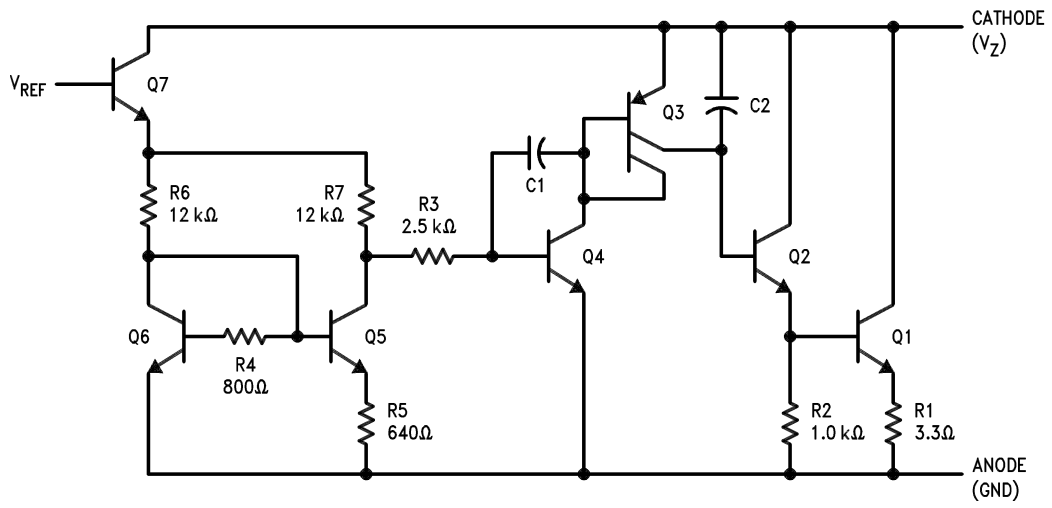
- (2) The dynamic output impedance, r_Z, is defined as:

$$r_Z = \frac{\Delta V_Z}{\Delta I_Z}$$

When the device is programmed with two external resistors, R₁ and R₂, (see Figure 5), the dynamic output impedance of the overall circuit, r_Z, is defined as:

$$r_Z = \frac{\Delta V_Z}{\Delta I_Z} \approx \left[r_Z \left(1 + \frac{R_1}{R_2} \right) \right]$$

Equivalent Circuit



Typical Performance Characteristics

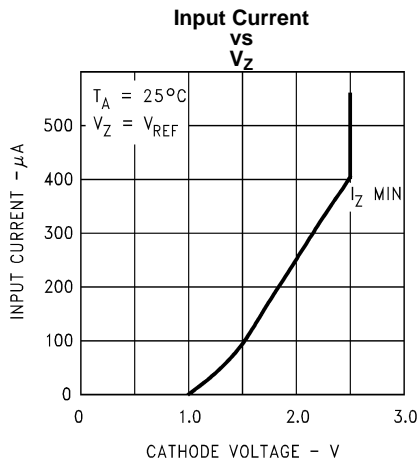


Figure 7.

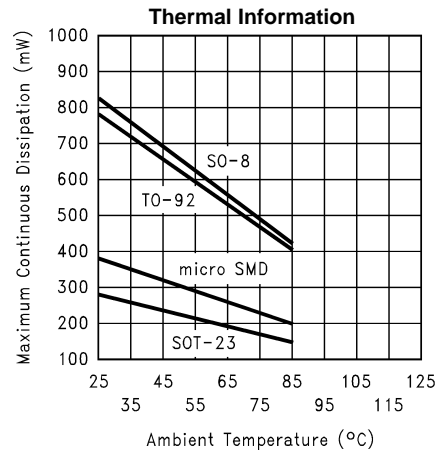


Figure 8.

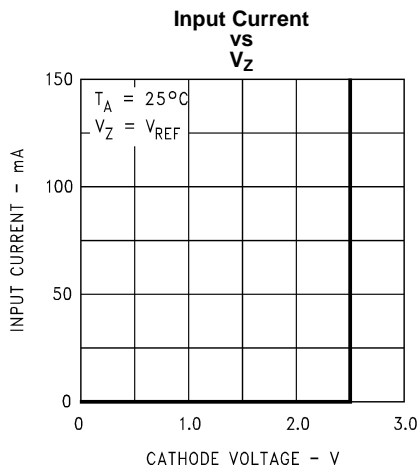


Figure 9.

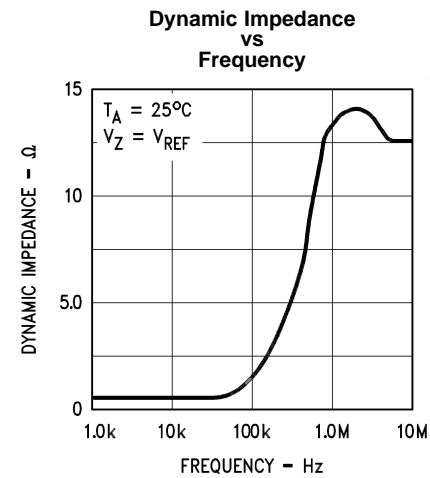
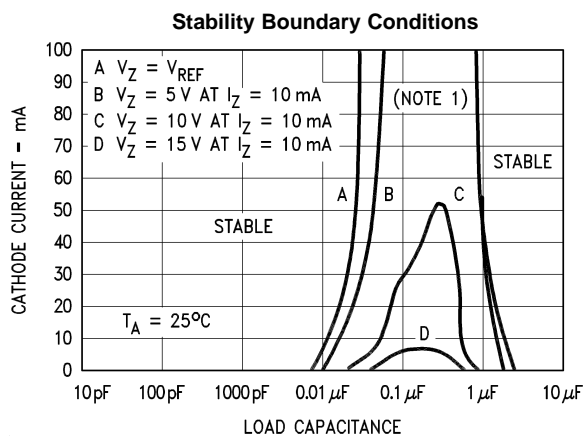


Figure 10.



Note: The areas under the curves represent conditions that may cause the device to oscillate. For curves B, C, and D, R2 and V⁺ were adjusted to establish the initial V_Z and I_Z conditions with C_L = 0. V⁺ and C_L were then adjusted to determine the ranges of stability.

Figure 11.

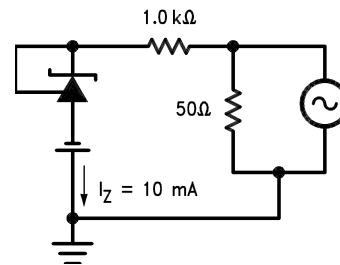


Figure 12.

Typical Performance Characteristics (continued)

Test Circuit for Curve A Above

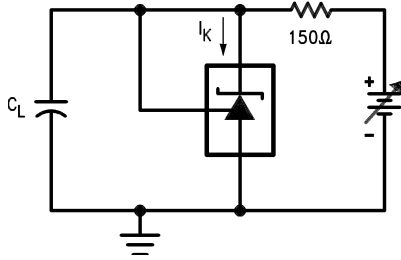


Figure 13.

Test Circuit for Curves B, C and D Above

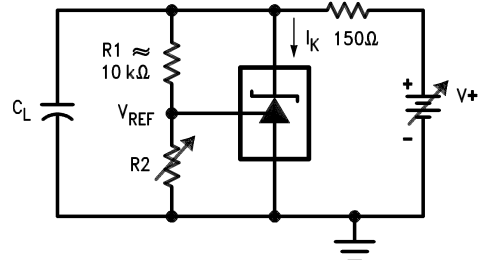


Figure 14.

Typical Applications

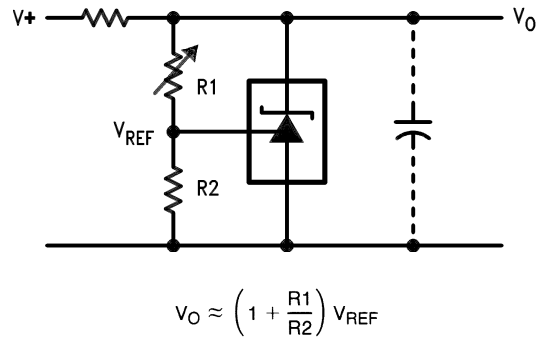


Figure 15. Shunt Regulator

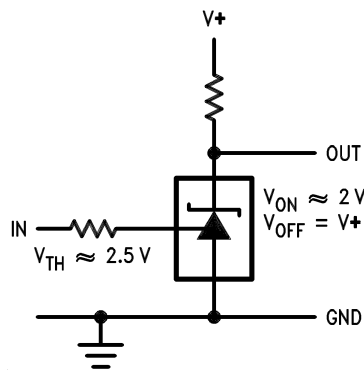


Figure 16. Single Supply Comparator with Temperature Compensated Threshold

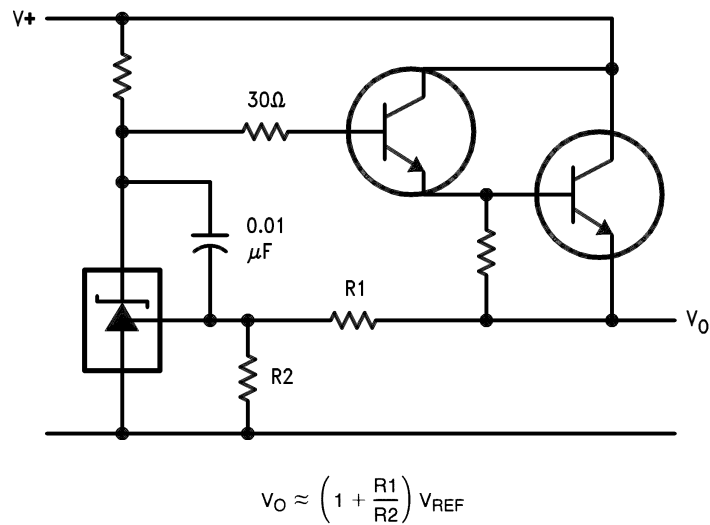
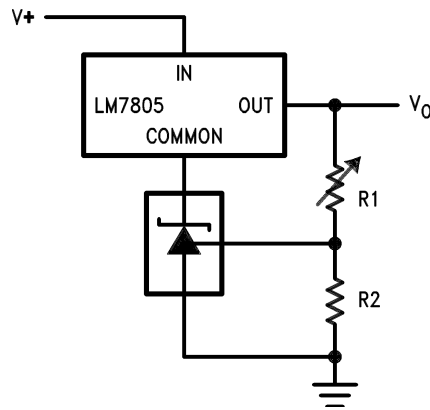


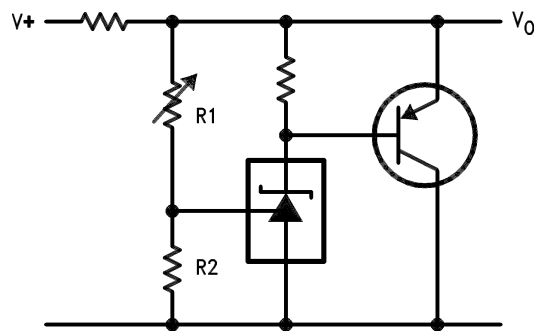
Figure 17. Series Regulator



$$V_O = \left(1 + \frac{R1}{R2}\right) V_{REF}$$

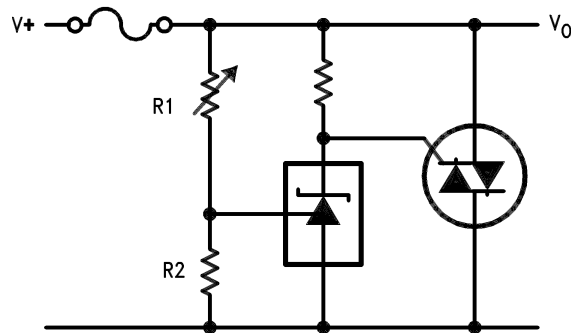
$$V_{O\ MIN} = V_{REF} + 5V$$

Figure 18. Output Control of a Three Terminal Fixed Regulator



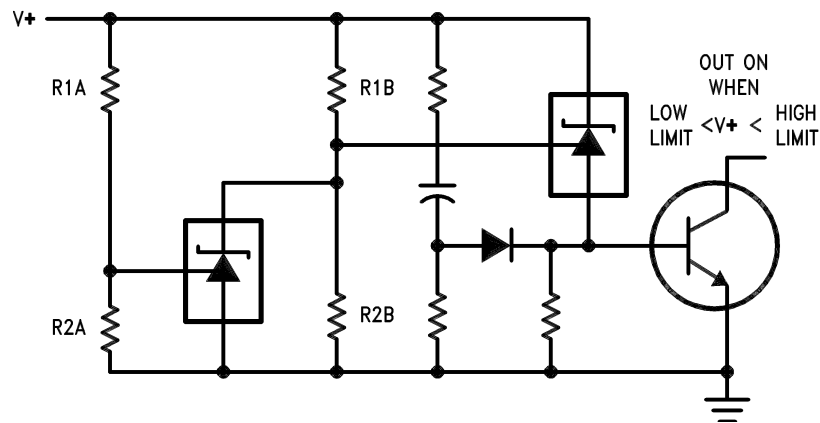
$$V_O \approx \left(1 + \frac{R1}{R2}\right) V_{REF}$$

Figure 19. Higher Current Shunt Regulator



$$V_{LIMIT} \approx \left(1 + \frac{R1}{R2}\right) V_{REF}$$

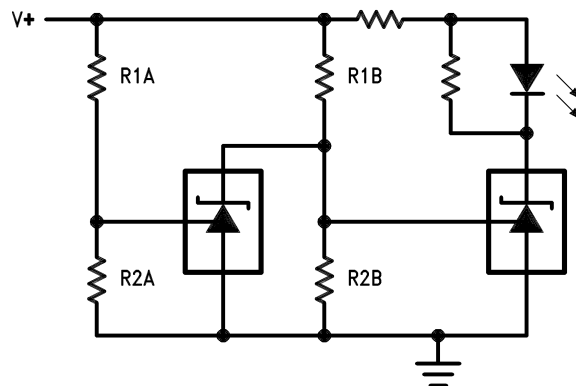
Figure 20. Crow Bar



$$\text{LOW LIMIT} \approx V_{\text{REF}} \left(1 + \frac{R1B}{R2B} \right) + V_{\text{BE}}$$

$$\text{HIGH LIMIT} \approx V_{\text{REF}} \left(1 + \frac{R1A}{R2A} \right)$$

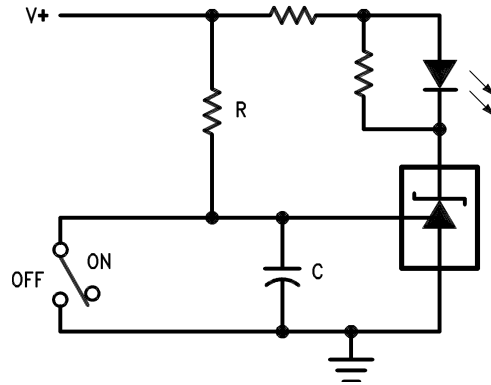
Figure 21. Over Voltage/Under Voltage Protection Circuit



$$\text{LOW LIMIT} \approx V_{\text{REF}} \left(1 + \frac{R1B}{R2B} \right) \quad \text{LED ON WHEN LOW LIMIT} < V^+ < \text{HIGH LIMIT}$$

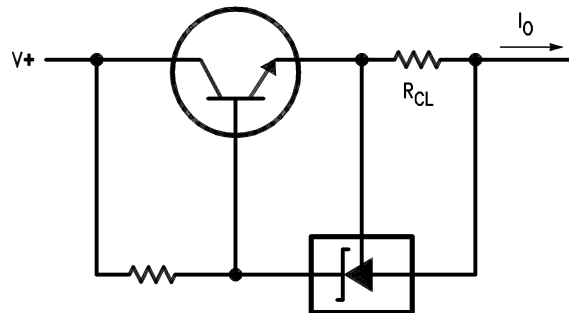
$$\text{HIGH LIMIT} \approx V_{\text{REF}} \left(1 + \frac{R1A}{R2A} \right)$$

Figure 22. Voltage Monitor



$$\text{DELAY} = R \cdot C \cdot \ln \frac{V^+}{(V^+) - V_{\text{REF}}}$$

Figure 23. Delay Timer



$$I_o = \frac{V_{\text{REF}}}{R_{\text{CL}}}$$

Figure 24. Current Limiter or Current Source

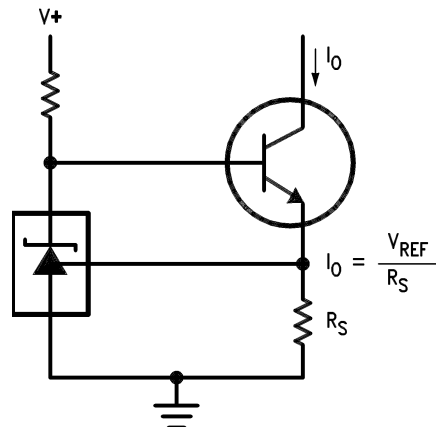


Figure 25. Constant Current Sink

REVISION HISTORY

Changes from Revision F (April 2013) to Revision G	Page
• Changed layout of National Data Sheet to TI format	10

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM431ACM	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 85	LM431 ACM	Samples
LM431ACM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LM431 ACM	Samples
LM431ACM3	ACTIVE	SOT-23	DBZ	3	1000	TBD	Call TI	Call TI	-40 to 85	N1F	Samples
LM431ACM3/NOPB	ACTIVE	SOT-23	DBZ	3	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1F	Samples
LM431ACM3X	ACTIVE	SOT-23	DBZ	3	3000	TBD	Call TI	Call TI	-40 to 85	N1F	Samples
LM431ACM3X/NOPB	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1F	Samples
LM431ACMX	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 85	LM431 ACM	Samples
LM431ACMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LM431 ACM	Samples
LM431ACZ/LFT3	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM		LM431 ACZ	Samples
LM431ACZ/LFT4	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM		LM431 ACZ	Samples
LM431ACZ/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 85	LM431 ACZ	Samples
LM431AIM	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 85	LM431 AIM	Samples
LM431AIM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LM431 AIM	Samples
LM431AIM3	ACTIVE	SOT-23	DBZ	3	1000	TBD	Call TI	Call TI	-40 to 85	N1E	Samples
LM431AIM3/NOPB	ACTIVE	SOT-23	DBZ	3	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1E	Samples
LM431AIM3X	ACTIVE	SOT-23	DBZ	3	3000	TBD	Call TI	Call TI	-40 to 85	N1E	Samples
LM431AIM3X/NOPB	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1E	Samples
LM431AIMX	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 85	LM431 AIM	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM431AIMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	LM431 AIM	Samples
LM431AIZ/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM		LM431 AIZ	Samples
LM431AIZ/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 85	LM431 AIZ	Samples
LM431BCM	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 85	431 BCM	Samples
LM431BCM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	431 BCM	Samples
LM431BCM3	ACTIVE	SOT-23	DBZ	3	1000	TBD	Call TI	Call TI	-40 to 85	N1D	Samples
LM431BCM3/NOPB	ACTIVE	SOT-23	DBZ	3	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1D	Samples
LM431BCM3X/NOPB	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1D	Samples
LM431BCMX	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 85	431 BCM	Samples
LM431BCMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	431 BCM	Samples
LM431BCZ/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 85	LM431 BCZ	Samples
LM431BIM	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 85	431 BIM	Samples
LM431BIM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	431 BIM	Samples
LM431BIM3	ACTIVE	SOT-23	DBZ	3	1000	TBD	Call TI	Call TI	-40 to 85	N1C	Samples
LM431BIM3/NOPB	ACTIVE	SOT-23	DBZ	3	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1C	Samples
LM431BIM3X	ACTIVE	SOT-23	DBZ	3	3000	TBD	Call TI	Call TI	-40 to 85	N1C	Samples
LM431BIM3X/NOPB	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1C	Samples
LM431BIMX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	431 BIM	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM431CCM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	431 CCM	Samples
LM431CCM3	ACTIVE	SOT-23	DBZ	3	1000	TBD	Call TI	Call TI	-40 to 85	N1B	Samples
LM431CCM3/NOPB	ACTIVE	SOT-23	DBZ	3	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1B	Samples
LM431CCM3X	ACTIVE	SOT-23	DBZ	3	3000	TBD	Call TI	Call TI	-40 to 85	N1B	Samples
LM431CCM3X/NOPB	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1B	Samples
LM431CCZ/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 85	LM431 CCZ	Samples
LM431CIM	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 85	431 CIM	Samples
LM431CIM/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	431 CIM	Samples
LM431CIM3	ACTIVE	SOT-23	DBZ	3	1000	TBD	Call TI	Call TI	-40 to 85	N1A	Samples
LM431CIM3/NOPB	ACTIVE	SOT-23	DBZ	3	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1A	Samples
LM431CIM3X	ACTIVE	SOT-23	DBZ	3	3000	TBD	Call TI	Call TI	-40 to 85	N1A	Samples
LM431CIM3X/NOPB	ACTIVE	SOT-23	DBZ	3	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	N1A	Samples
LM431CIZ/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM		LM431 CIZ	Samples
LM431CIZ/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 85	LM431 CIZ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

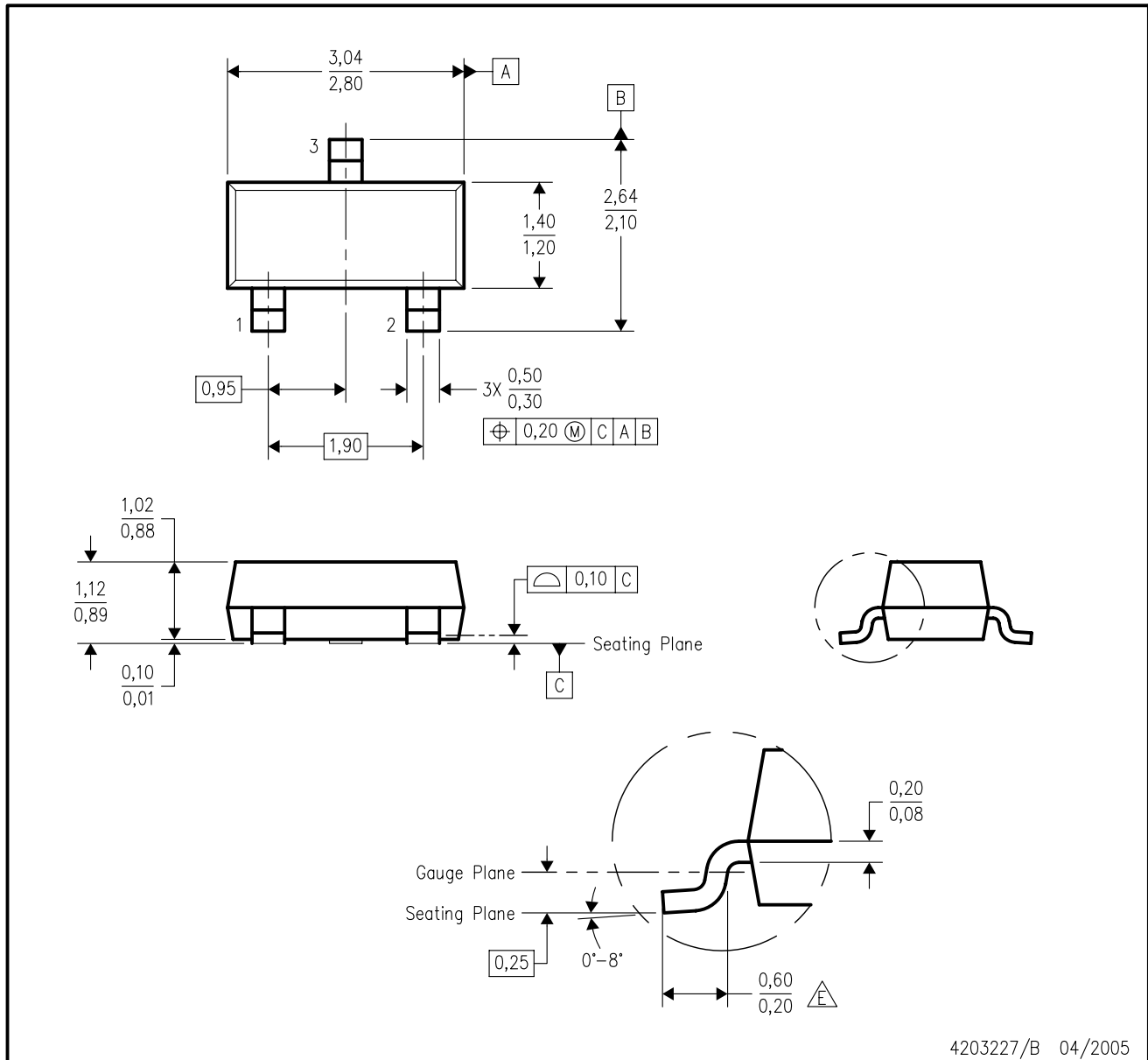
⁽⁴⁾ Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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DBZ (R-PDSO-G3)

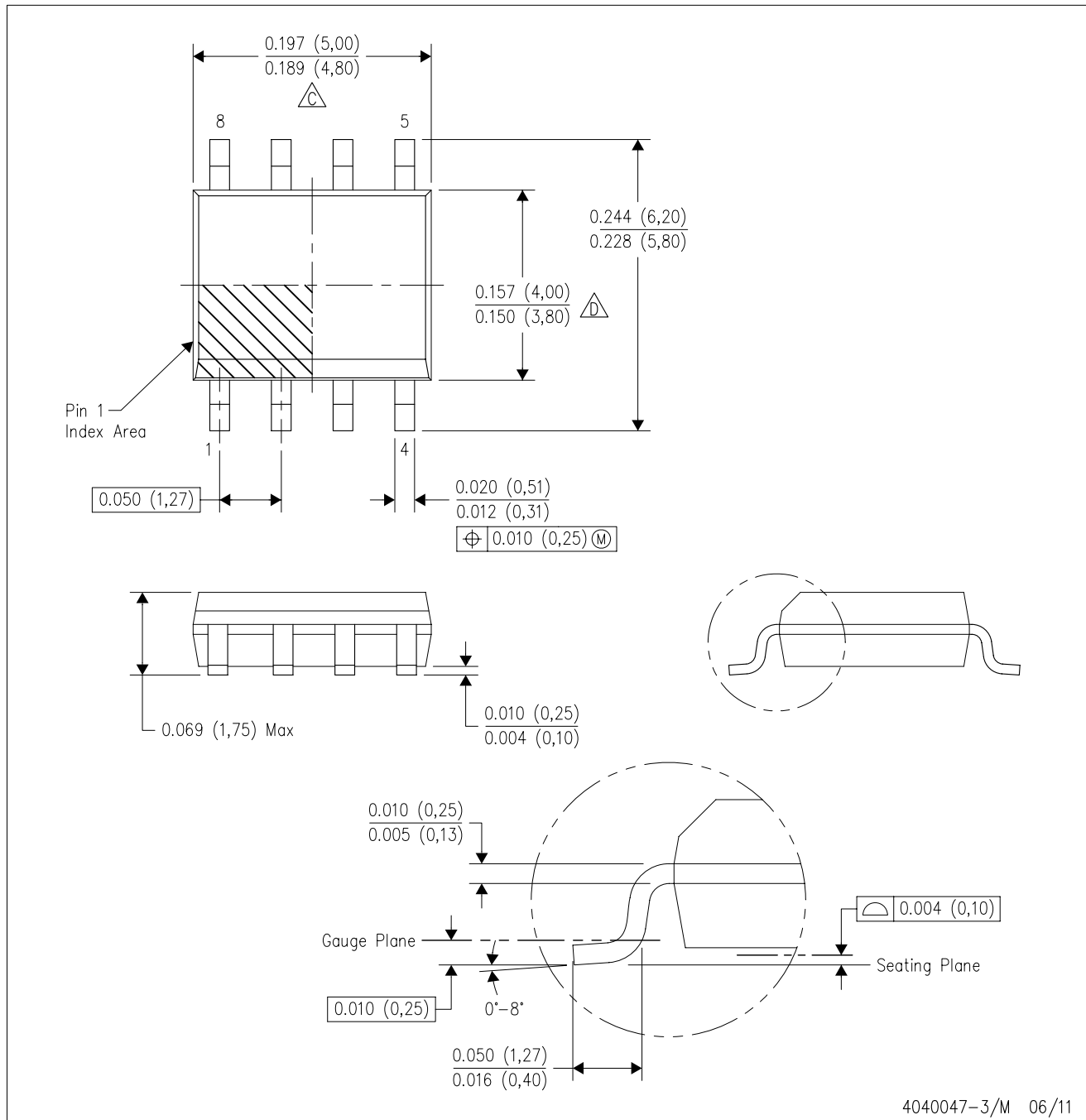
PLASTIC SMALL-OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Lead dimensions are inclusive of plating.
 - D. Body dimensions are exclusive of mold flash and protrusion. Mold flash and protrusion not to exceed 0.25 per side.
 - $\triangle E$ Falls within JEDEC TO-236 variation AB, except minimum foot length.

D (R-PDSO-G8)

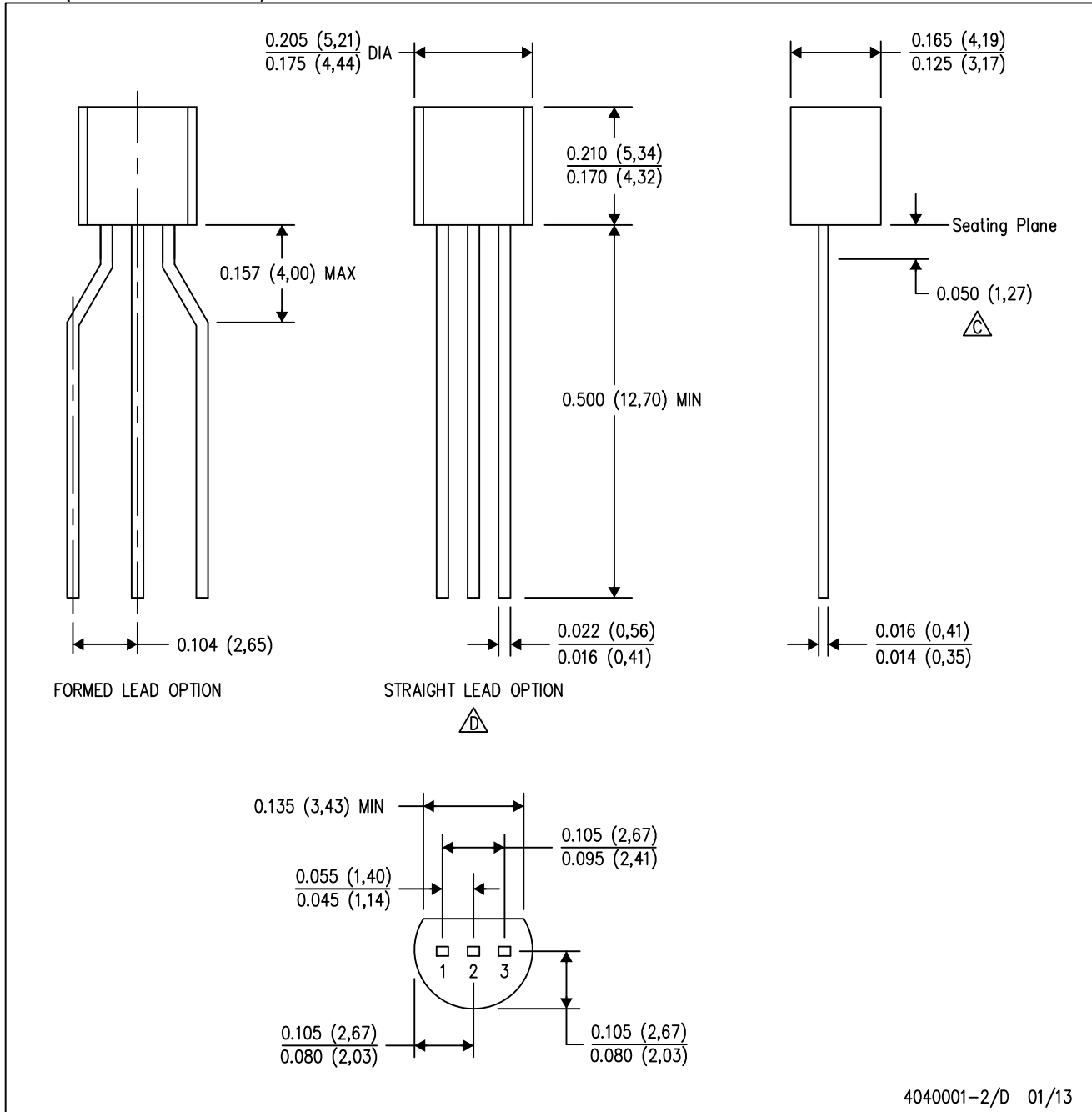
PLASTIC SMALL OUTLINE



4040047-3/M 06/11

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE

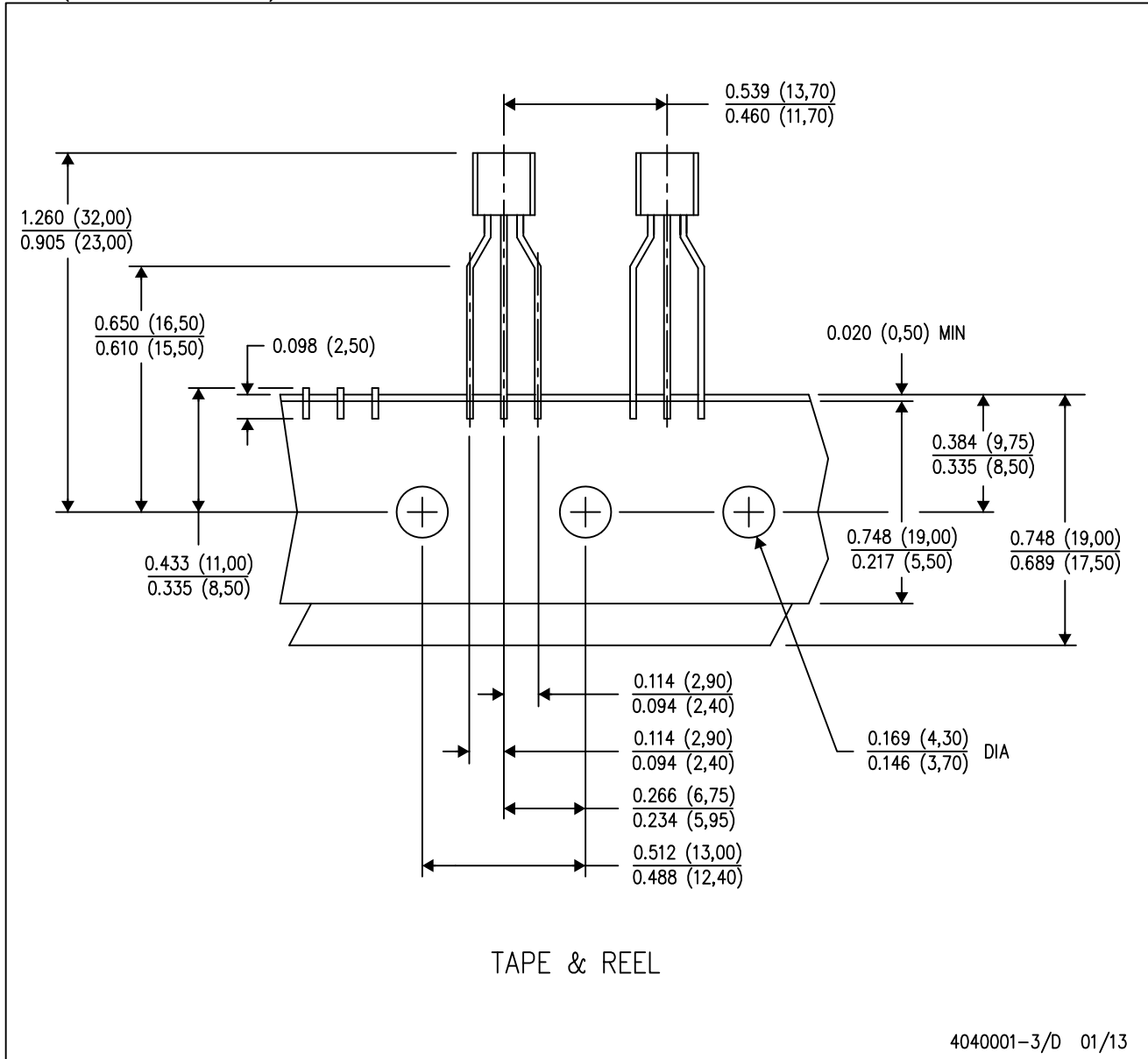


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Lead dimensions are not controlled within this area.
 - D. Falls within JEDEC TO-226 Variation AA (TO-226 replaces TO-92).
 - E. Shipping Method:
 - Straight lead option available in either bulk pack or tape & reel.
 - Formed lead option available in tape & reel or ammo pack.
 - Specific products can be offered in limited combinations of shipping mediums and lead options.
 - Consult product folder for more information on available options.

MECHANICAL DATA

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Tape and Reel information for the Formed Lead Option package.

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